





# ENG-E18-107– Distributors

JAE Electronics, Inc.  
May 14<sup>th</sup>, 2018

## PCN (Process Change Notice) MX19S10K451 and M19S09K3F2 Additional Stamp Die To Keep Product Capacity

Part Number	1 Existing Stamp Die with 1 stamp line as marked below	1 Additional Stamp Die with 1 stamp Line as Marked below	Additional Stamp Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX19S10K451 M19S09K3F2			June 2018	June 2018	July 2018

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you request PPAP documents, please notify us ASAP.